# EVERLIGHT EVERLIGHT ELECTRONICS CO.,LTD.

### **Technical Data Sheet**

# 0402 Package Chip LED (0.45mm Height)

### 16-213/T3D-CP2Q2TY/3T

#### **Features**

- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.
- Pb-free.
- The product itself will remain within RoHS compliant version.

### **Descriptions**

- board size, higher packing density, reduced storage space and finally smaller equipment to be obtained. • The 16-213 SMD Taping is much smaller than .com.cr
- Besides, lightweight makes them ideal for miniature applications. etc.

### **Applications**

- Backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

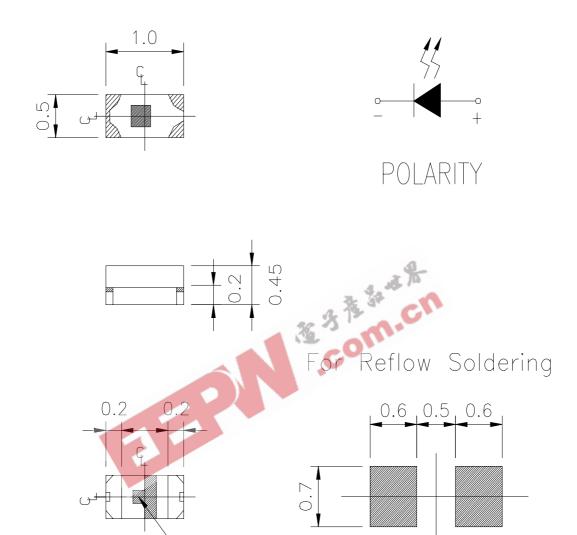
#### **Device Selection Guide**

D (N)			
Part No.	Material	<b>Emitted Color</b>	Lens Color
16-213/T3D-CP2Q2TY/3T	InGaN	Pure White	Yellow Diffused



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# **Package Outline Dimensions**



**Note:** The tolerances unless mentioned is  $\pm 0.1$ mm ,Unit = mm

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Cathode Mark



# EVERLIGHT ELECTRONICS CO.,LTD.

### 16-213/T3D-CP2Q2TY/3T

### **Absolute Maximum Ratings (Ta=25℃)**

Parameter	Symbol	Rating	Unit		
Reverse Voltage	$V_R$	5	V		
Forward Current	$\mathbf{I}_{\mathrm{F}}$	25	mA		
Peak Forward Current (Duty 1/10 @1KHz)	IFP	100	mA		
Power Dissipation	Pd	110	mW		
Electrostatic Discharge(HBM)	ESD	150	V		
Operating Temperature	Topr	-40 ~ +85	$^{\circ}\! \mathbb{C}$		
Storage Temperature	Tstg	-40 ~ +90	$^{\circ}\! \mathbb{C}$		
Soldering Temperature  Tsol  Reflow Soldering: 260 °C for 10 sec.  Hand Soldering: 350 °C for 3 sec.					
Soldering Temperature  Tsol  Hand Soldering: 350 °C for 3 sec.					

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### **Electro-Optical Characteristics (Ta=25°C)**

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Luminous Intensity	Iv	57		112	mcd	
Viewing Angle	2 \theta 1/2		130		deg	IF=5mA
Forward Voltage	$V_{F}$	2.6		3.0	V	
Reverse Current	Ir			50	$\mu$ A	V <sub>R</sub> =5V

Bin Range Of Luminous Intensity & Forward Voltage

Symbol	Bin Code	Min.	Max.	Unit	Condition
Iv	P2	57	72	1. 18 16	
	Q1	72	90	mcd	I <sub>F</sub> =5mA
	Q2	90	112	14.	
VF	28	2.6	2.7		
	29	2.7	2.8		
	30	2.8	2.9	V	I <sub>F</sub> =5mA
	31	2.9	3.0		

### **Notes:**

1.Tolerance of Luminous Intensity ±10%

2.Tolerance of Forward Voltage ±0.05V

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# **Chromaticity Coordinates Specifications for Bin Grading**

Group	Bin Code	CIE_x	CIE_y	Condition
	1	0.274	0.226	
		0.274	0.258	
	1	0.294	0.286	
		0.294	0.254	
		0.274	0.258	
	2	0.274	0.291	
		0.294	0.319	
C		0.294	0.286	IF= 5mA
	3	0.294	0.254	IF— JIIIA
		0.294	0.286	
		0.314	0.315	
		0.314	0.282	
	4	0.294	0.286	
		0.294	0.319	
		0.314	0.347	
		0.314	0.315	

### **Notes:**

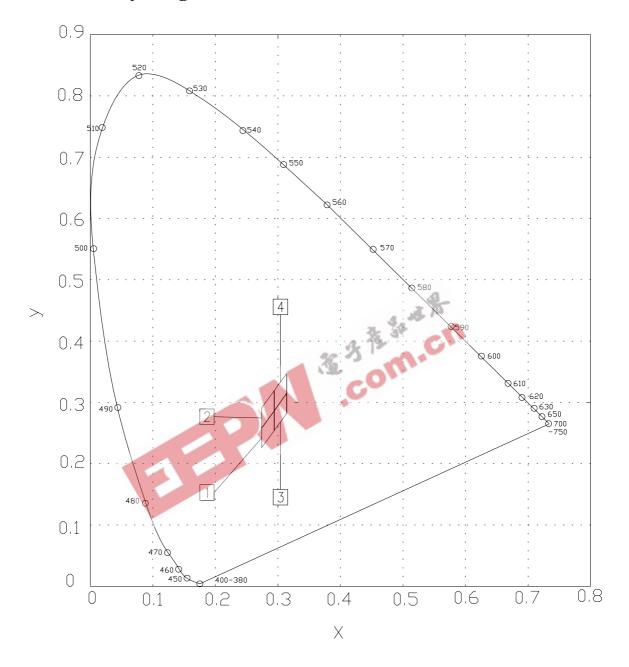
- 1.The C.I.E. 1931 chromaticity diagram (Tolerance  $\pm 0.01$ ).
- 2. The products are sensitive to static electricity and care must be fully taken when handling products.

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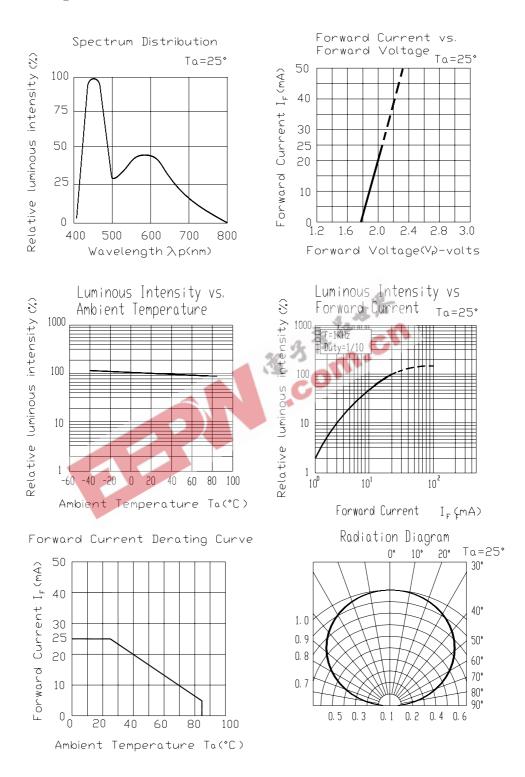
# **CIE Chromaticity Diagram**



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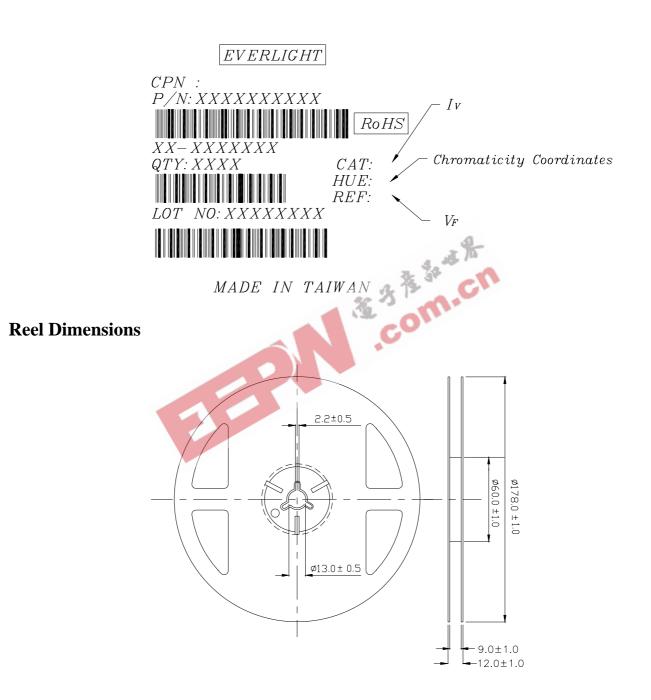
### **Typical Electro-Optical Characteristics Curves**



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### Label explanation

CAT: Luminous Intensity Rank HUE: Chromaticity Coordinates REF: Forward Voltage Rank

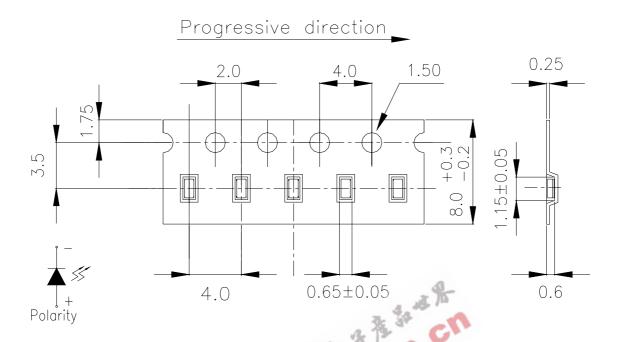


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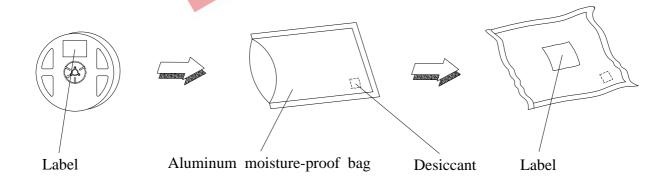


### Carrier Tape Dimensions: Loaded quantity 3000 PCS per reel



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### **Moisture Resistant Packaging**



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### **Reliability Test Items And Conditions**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

No.	Items	Test Condition	Test Hours/Cycles	Sample Size	Ac/Re
1	Reflow Soldering	Temp. : 260°C±5°C Min. 5sec.	6 Min.	22 PCS.	0/1
2	Temperature Cycle	$H: +100^{\circ}\mathbb{C}$ 15min $\int$ 5 min $L: -40^{\circ}\mathbb{C}$ 15min	300 Cycles	22 PCS.	0/1
3	Thermal Shock	H:+100°C 5min ∫ 10 sec L:-10°C 5min	300 Cycles	22 PCS.	0/1
4	High Temperature Storage	Temp. : 100℃	1000 Hrs.	22 PCS.	0/1
5	Low Temperature Storage	Temp. : -40°C	1000 Hrs.	22 PCS.	0/1
6	DC Operating Life	$I_F = 20 \text{ mA}$	1000 Hrs.	22 PCS.	0/1
7	High Temperature / High Humidity	85°C / 85%RH	1000 Hrs.	22 PCS.	0/1

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### **Precautions For Use**

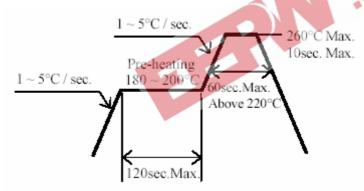
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - Do not open moisture proof bag before the products are ready to use.
  - 2.2 Before opening the package: The LEDs should be kept at  $30^{\circ}$ C or less and 90%RH or less.
  - 2.3 After opening the package: The LED's floor life is 1 year under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.
  - 2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the Jolowin, storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $350^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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